

FUJITSU

CMOS SINGLE-CHIP
4-BIT MICROCOMPUTER
WITH ONE TIME PROM

MB88P505H

ONE TIME PROGRAMMABLE READ ONLY MEMORY VERSION OF HIGH-SPEED CMOS SINGLE-CHIP 4-BIT MICROCOMPUTER

The Fujitsu MB88P505H has One Time PROM(OTPROM) for program memory, they are include by the MB88500H series. Its architecture and instruction set are the same as the MB88505H, packaged in a same package.

MB88P505H contains a 4K by 8-bit OTPROM (program memory) by 8-bit, 256 by 4-bit static RAM (data memory), 36 I/O lines (including a serial I/O port with a 4-/8-bit buffer), an 8-bit timer/counter, and a clock generator.

Its instruction execution time is 1.5 μ s min. at a 8 MHz crystal with a prescaler. These devices are fabricated by silicon-gate CMOS process, and packaged in an 42-pin plastic standard/shrink DIP (suffix -P/-PSH) or 48-pin plastic flat package (suffix -PF). It operate with +5V power supply over the temperature range of -30°C to +70°C.

For quickly provide, Fujitsu provide the two standard versions (-101 and -102).* Also, Fujitsu can prepare the same option for MB88505H as a customer request.

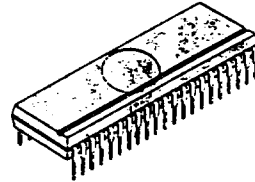
For programming of One Time PROM which include the MB88P505H, Fujitsu provide the exclusive writer (MB2115-100 and -102) which include the MB2115 series. By use this writer, customer can write themselves. So customer can reduce the Turn Around Time, change/modify the program is easy.

To minimize system cost and development time. Fujitsu provides a complete complement of hardware and software development tools.

* Standard version's package is a 42-pin standard DIP only.

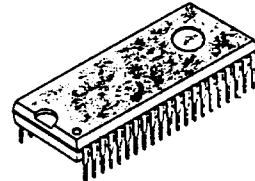
TM330-B872: February 1987

MB88P505H-P *



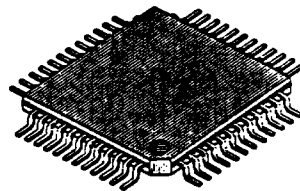
42-PIN PLASTIC STANDARD DIP
(DIP-42P-M01)

MB88P505H-PSH



42-PIN PLASTIC SHRINK DIP
(DIP-42P-M02)

MB88P505H-PF



48-PIN PLASTIC FLAT PACKAGE
(FPT-48P-M02)

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

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FEATURES

- One Time PROM Version of CMOS Single Chip 4-bit Microcomputer
- Program Memory: 4K x 8-bit one time PROM
- Data Memory: 256 x 4-bit static RAM
- 36 I/O Lines:
 - K-Port: 4-bit parallel input only port
 - P-Port: 4-bit parallel output only port
 - O-Port: Dual 4-bit parallel input/output port
 - R-Port: Four 4-bit parallel or 16 individual input/output port
 - C-Port: Serial I/O, interrupt input, timer/counter input, and timing output
- Three Selectable Output Port (O-, P-, R-Ports) Circuits with Mask option:
 - Standard open-drain: (-102)
 - Standard pullup : (-101)
- 8-bit Programmable Timer/Counter with Auto-loading Function and Two Clock Modes:
 - Internal (Timer)
 - External (Counter)
- Software Selectable 4-/8-bit Serial Buffer with 3 Software Shift Clock Modes:
 - Internal clock
 - External clock
 - Software clock
- On-chip Clock Generator with Two Mask Options:
 - External crystal/ceramic resonator or external clock drive (-101, -102)
 - External RC-network or external clock drive
- Selectable 1/2 Clock Prescaler for Expanding Clock Range with Mask Options:
 - Without prescaler
 - With prescaler (-101, -102)
- Single Level Four Prior Source Maskable Interrupt:
 - External
 - Clock
 - Timer/counter overflow
 - Serial buffer full/empty
 -
- 8-nesting Levels for Subroutine Call
- Instruction Set : Same as the MB88505 and MB88505H
 - Number of instructions : 76
 - Instruction length/cycle: 1, 2, or 3 bytes/1, or 2 cycle
 - Execution time : 1.5 μ s min. using 8 MHz clock with prescaler
- On-chip Power-on Reset Circuit
- Two Selectable Output Port (P-Port) Level During Reset with Mask Option:
 - High level (-101, -102)
 - Low level

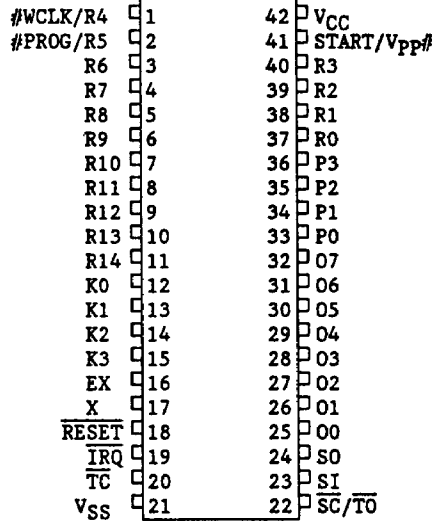
FEATURES (Continued)

- Selectable Low Power Standby Function (Software initiation and hardware release) with Mask Option:
 - o Yes (-101, -102)
 - o No
- Two Selectable Output During Standby with Mask Option:
 - o Hold (-102)
 - o High impedance (-101)
- Two Software Selectable Oscillation States During Standby:
 - o Idle
 - o Stop
- Selectable Standby Off Reset with Mask Option:
 - o Yes
 - o No (-101, -102)
- Selectable Watch-dog Timer Function with Mask Option:
 - o Yes
 - o No (-101, -102)
- Low Power Dissipation:
 - o 6 mA at $f_c=1$ MHz typ. (Active mode)
 - o 10 μ A at $f_c=0$ MHz max. (Standby mode)
- Single +5V Power Supply:
 - o 4.5V to 5.5V (Active mode)
 - o 3.5V to 6.0V (Standby mode)
- Wide Operation Temperature Range: $T_A = -30$ °C to + 70 °C
- Silicon Gate CMOS Technology
- Three Selectable Package by Mask Option:
 - o 42-Pin plastic standard DIP: DIP-42P-M01 (-101, -102)
 - o 42-Pin plastic shrink DIP: DIP-42P-M02
 - o 48-Pin plastic flat package: FPT-48P-M02
- To Programming, Exclusive Writer (MB2115-100, -102)
- Powerful Development Support (Refer to Table 8)

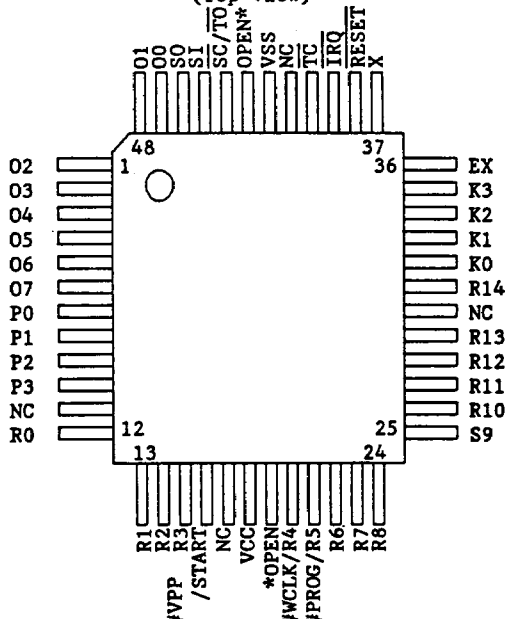
Note: Suffix -101 and -102 indicate a kind of the standard version.

Fig. 1: PIN ASSIGNMENT

Suffix -P and -PSH
(Top view)



Suffix -PF
(Top View)

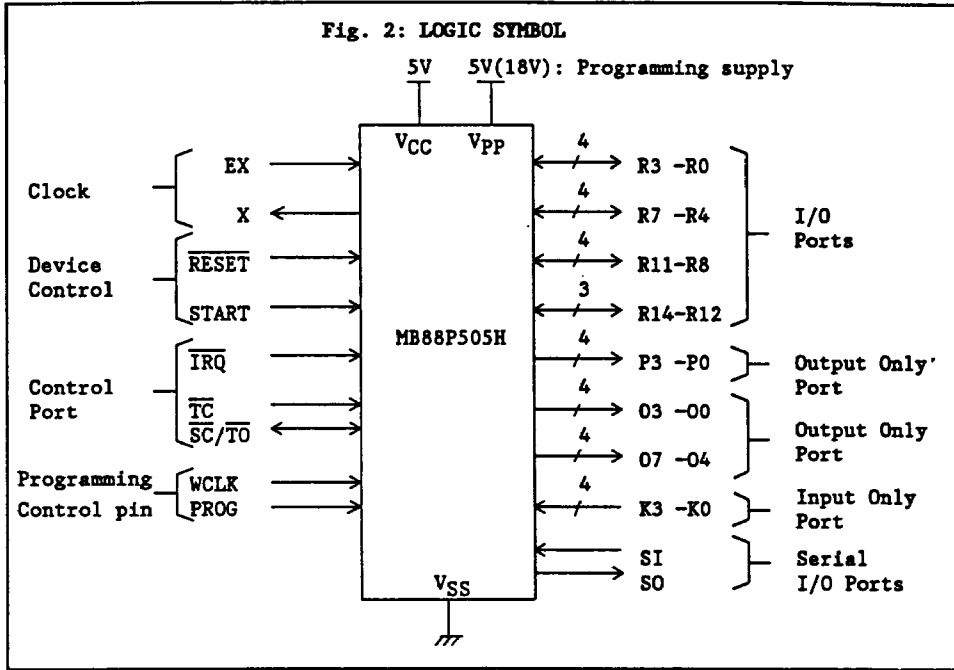


Note:

These pins are used for the programming of internal OTPROM. (Pin assignment is different from produced device (MB88505 and MB88505H))

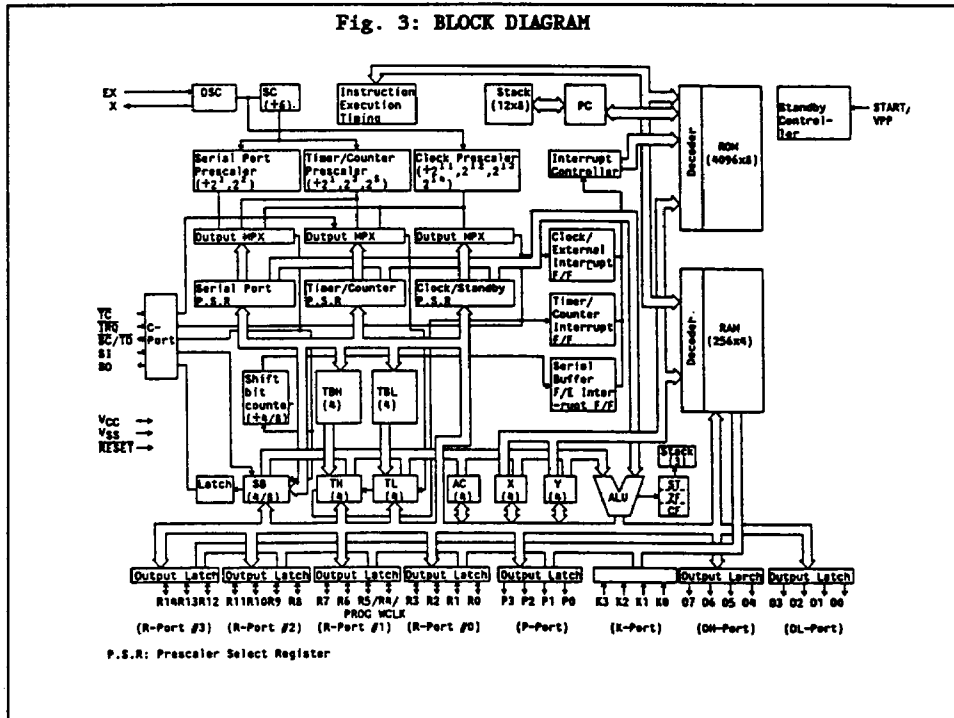
* This pin should not to be connect.

Fig. 2: LOGIC SYMBOL



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Fig. 3: BLOCK DIAGRAM



PIN DESCRIPTION

Fig. 1 and Table 1 show the pin assignment and pin description of the MB88P505H.

Table 1: PIN DESCRIPTION

Symbol	Pin No.	Type	Name & Function
• Power Supply			
V _{CC}	42 (18)	-	+5V DC power supply pin.
V _{SS}	21 (42)	-	Ground pin.
• Clock			
EX	16 (36)	I	<p>Oscillator Input: Input to the inverting amplifier that forms the on-chip oscillator. An external crystal/ceramic resonator or RC-network is connected between the EX and X pins. Either of these two oscillation types can be selected using mask option. When an external oscillator is used, the EX pin receives the external oscillator signal.</p> <p>This pin is a non-hysteresis input when the crystal/ceramic oscillator is selected, and a hysteresis input when the RC-network oscillator is selected.</p> <p>Standard chip (Suffix -101 or -102) are fixed at crystal/ceramic resonator.</p>
X	17 (37)	O	<p>Oscillator Output: Output of the inverting amplifier that forms the on-chip oscillator, and input to the internal clock generator. An external crystal/ceramic resonator or RC-network is connected between the EX and X pins. Either of these two oscillator types can be selected using mask option. When an external oscillator is used, the X pin should be left open.</p>
• Device Control			
RESET	18 (38)	I/O	<p>Reset: This pin function as an external reset input or power-on reset output.</p> <p>External reset input: A reset input to the internal reset circuit. A low level on the RESET pin forcedely stops the MCU's operation, and initializes its internal state. After the RESET pin returns high, the MCU re-starts execution of program from address #0. The RESET pulse must be low for at least two instruction cycles while the oscillator is stably running after power-on. This pin is a hysteresis input with an internal pullup resistor. An external capacitor from the RESET pin to the V_{SS} pin (and the internal pull-up resistor), whose time constant should be greater than the reset time required (12 clock periods) composes the external reset circuit.</p>

Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Type	Name & Function
• Device Control (Continued)			
RESET	18 (38)	I/O	<p>Power on reset output: A reset output from the on-chip reset control circuit. Normally this output is high during the active operation except the reset mode. The rising of the <u>VCC</u> voltage after power on outputs a low level on the RESET pin, and then automatically returns high after it has passed 2¹⁸ clock periods since the oscillator starts by power on.</p> <p>This pin is a hysteresis input with an internal pullup resistor.</p>
START	41 (16)	I	<p>Start: A standby release input to the internal standby control and status registers that control and monitor the on-chip standby control circuit. A high level on the START pin during the standby mode sets the standby release flag (STF) in the standby status register, resets the standby enable flag (STBE) in the standby control register, and triggers the standby release sequence to return the MCU to the active mode. Before the START pulse is applied, the VCC voltage must return to the active operation range (4.5V to 5.5V) when the battery backup is used. Also, the START pin must be low before the standby mode is initiated.</p> <p>The START pin state (logical level) is reflected in the standby release input (START) flag (STIF) in the standby status register, regardless of during the standby mode or active mode, and besides even when the standby function is not implemented using mask option. Therefore, the START pin state can be sensed by reading the standby status register using IN instruction (with Y=8).</p> <p>This pin is a hysteresis input with an internal pull-down resistor. Also, this pin function is assigned to VPP pin for programming the OTPROM.</p>
• C-Port			
IRQ	19 (39)	I	<p>Interrupt Request: A maskable external interrupt input to the on-chip interrupt control circuit. The falling edge of the IRQ pulse sets the external interrupt request flag (IRF) in the interrupt flag register regardless of enabling or disabling the external interrupt. If the external interrupt is enabled in advance by EN instruction, the interrupt sequence starts at once. Otherwise, the IRF flag is internally held as an interrupt source. Also, the IRQ pin state (logical level), which is reflected in the external interrupt input flag (IF) regardless of enabling or disabling the external interrupt, is testable using TSTI instruction. (When IRQ = L, IF = 1; otherwise IF = 0.)</p>

Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Type	Name & Function
• C-Port (Continued)			
$\overline{\text{IRQ}}$	19 (39)	I	This pin is a hysteresis input with an internal pullup resistor.
$\overline{\text{TC}}$	20 (40)	I	<p>Timer/Counter: An external count clock input to the on-chip 8-bit timer/counter. The falling edge of the TC pulse increments the timer/counter by one bit, when the external count clock (counter) mode is enabled by EN instruction programming the timer/counter prescaler select register using OUT instruction (with Y = B). Also, the TC pin state (logical level), which is reflected in the timer/counter input flag (TCF) in the timer/counter prescaler select register regardless of enabling or disabling the external count clock (counter) mode, is testable by reading the prescaler select register using IN instruction (with Y = B). (When TC = L, TCF = 1; otherwise TCF = 0.) This pin is inactive as a count clock input when the external count clock mode is not selected or the timer/counter is disabled by DIS instruction or reset.</p> <p>This pin is a hysteresis input with an internal pullup resistor.</p>
$\overline{\text{SC}}/\overline{\text{TO}}$	22 (44)	I/O	<p>Shift Clock/Timing Output: One of the shift clock input (SC), shift clock output ($\overline{\text{SC}}$), or synchronous timing output ($\overline{\text{TO}}$) is enabled using EN instruction.</p> <p>I</p> <p>$\overline{\text{SC}}$: 1) Shift clock input to the on-chip serial port: When the external shift clock mode is enabled for the serial port, the falling edge of the external SC clock shifts the contents of the internal serial buffer one bit right (from MSB to LSB). This input is inactive when the external clock mode is not selected or the serial port disabled by DIS instruction or reset. This pin is a hysteresis input.</p> <p>2) Shift clock output from the on-chip serial port: When the internal shift clock mode is enabled, the internal shift clock shifts the contents of the serial buffer one bit right. In this mode, the internal timing signal selected is output onto the SC pin for synchronization.</p> <p>0</p> <p>$\overline{\text{TO}}$: Synchronous timing output: When the timing output is enabled, the internal timing signal which is generated by the on-chip state counter output (pins #1 and #2) is output onto the $\overline{\text{TO}}$ pin. By DIS instruction or reset, the $\overline{\text{TO}}$ pin is disabled and stops issuing the timing output.</p>

Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Type	Name & Function
• C-Port (Continued)			
SI	23 (45)	I	Serial Data Input: Data input to the on-chip serial port. The rising edge of the external (\overline{SC}) or internal shift clock shifts the data bit on the SI pin into the MSB of the serial buffer register when the serial port is enabled by EN instruction. Also, the SI pin state (logical level) is reflected in the serial data input flag (SIF) in the serial port prescaler select register regardless of enabling or disabling the serial port. Therefore, the SI pin can be sensed by reading the prescaler register using IN instruction (with Y = A).
SO	24 (46)	O	Serial Data Output: Data output with latch of the on-chip serial port. The falling edge of the external (\overline{SC}) or internal shift clock shifts the LSB data of the serial buffer register to the serial port output latch, regardless of enabling or disabling to serial port. The content of the output latch directly appears on the SO pin. This pin is a CMOS pull up output, and is set high by reset.
• I/O Ports			
K3-K0	15-12 (35-32)	I	K-Port: A 4-bit parallel non-latched input only port. K0 is LSB. 4-bit data on K-Port is input into the accumulator by INK instruction. These pins are internally pullup.
P3-P0	36-33 (10-7)	O	P-Port: A 4-bit parallel latched output only port. P0 is LSB. 4-bit data in the accumulator is output to P-Port by OUTP instruction. Refer to Table 4 User mask options for available making option. For standard version device, port option of MB88P505H-101 is standard pullup, MB88P505H-102 is standard open-drain output.
03-00, 07-00	28-25 (2,1,48, 47) 32-39 (6-3)	O	O-Port: An dual 4-bit parallel latched output only port. 00 and 04 are LSB. By OUTO instruction, 4-bit data in the accumulator is output, without conversion, onto the lower nibble (03-00) or upper nibble (07-04) of O-Port, depending on whether the carry flag (CF) is "0" or "1". Refer to Table 5 User mask options for available making option. For standard version device, port option of MB88P505H-101 is standard pullup, MB88P505H-102 is standard open-drain output.

Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Type	Name & Function
• I/O Port (Continued)			
R3 -R0, R7 -R4, R11-R8, R14-R12	40-37, (15-12) 4- 1, (23-20) 8- 5, (27-24) 11- 9 (31,29, 28)	I/O	<p>R-Port: This port functions as three 4-bit parallel input and one 3-bit parallel input (non-latched)/output (latched) ports, or 15 individual input (non-latched)/output (latched) lines, depending on instructions.</p> <p>Parallel I/O: Each 4-bit and 3-bit port is named R-Port #0 (R3-R0), R-Port #1 (R7-R4), R-Port #2 (R11-R8), and R-Port #3 (R14-R12), and is indirectly addressed by the Y-register (Port #). 4-bit data in the accumulator is output to an addressed port of R-Ports #0 to #3 by OUT instruction. 4-bit data on the addressed port is input into the accumulator by IN instruction. (Before IN instruction, the port to be addressed must be set up to "1" state (input) mode.)</p> <p>Individual I/O: Each line from R14 to R0 is indirectly addressed by the Y-register (Bit #). The addressed line is individually set/reset by SETR/RSTR instruction, and especially each line of R-Port #0 (R3-R0) is directly set/reset by SETD/RSTD instruction. The addressed line is individually testable by TSTR instruction, and each line of R-Port #2 (R11-R8) is directly testable in particular by TSTD instruction. (Before the TSTR and TSTD instructions, the line to be addressed must be set up to "1" (input) mode.)</p> <p>Refer to Table 4 MB88P505H-5XX customized user mask option and Table 5 MB88P505H-101 AND -102 standard version User mask options for available making option.</p> <p>For standard version device, port option of MB88P505H-101 is standard pullup, MB88P505H-102 is standard open-drain output.</p> <p>R4 and R5 are assigned the WCLK and PROG pin for programming the OTPROM.</p>

Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Type	Name & Function
• Programming			
VPP	41 (16)	-	<p>PROM Supply Pin: +18V/+5V power supply pin. When program to the internal PROM, +18V power supply connect to this pin. In normal operation (non-programming mode), should be connect to the VCC pin for internal PROM.</p> <p>This pin is common to START pin.</p>
PROG	2 (21)	I	<p>Programming: Program enable signal input for data program to the internal PROM. When data program to the internal PROM, set to a High for enable the programming. In operation, set to a Low for disable the programming.</p> <p>This pin is common to R5 pin.</p>
WCLK	1 (20)	I	<p>Programming Clock: Programming pulse input for data program to the internal PROM. When data program to the internal PROM.</p> <p>This pin is common to R4 pin.</p>
NC	(11,17, 30,41)	-	Non Connection: These pin are non connection pin.
OPEN	(19,43)	-	Open: These pin should not to be connect.

Note: Parenthesis number is applied to suffix -PF,

DIFFERENCES BETWEEN MB88505/H AND MBP88505H

Following differences are user requested option (customized) devices (suffix -5XX) and MB88505/H. User requested option is indicate by suffix as -5XX.

Table 2: DIFFERENCES BETWEEN MB88505/H AND MB88P505H

Device Item	MB88505	MB88505H	MB88P505H	Notes
ROM	Internal mask ROM	Internal mask ROM	Internal PROM	
Pin: - Pin 1 (20) - Pin 2 (21) - pin 41(16)	· R4 · R5 · START	· R4 · R5 · START	· R4/WCLK · R5/PROG · START/VPP	
fc (Clock frequency*)	Min. 0.5MHz	Min. 2 MHz	Min. 0.5MHz	OTP ROM version (H) can cover mask ROM parts' H and non-H.
	Max. 3 MHz	Max. 4 MHz	Max. 4 MHz	
ICC (VCC active supply current)	Typ. 2mA (fc= 1MHz, VCC=5.0V, Outputs open)	Typ. 4mA (fc= 2MHz, VCC=5.0V, Outputs open)	Typ. 2mA (fc= 1MHz, VCC=5.0V, Outputs open)	
	Max. 6mA (fc= 1MHz, VCC=5.5V, Outputs open)	Typ. 12mA (fc= 2MHz, VCC=5.5V, Outputs open)	Max. 6mA (fc= 1MHz, VCC=5.5V, Outputs open)	
ICCH (VCC standby supply current)	Max. 10µA (fc=0Hz, VCC=6.0V, Outputs open)	Max. 10µA (fc=0Hz, VCC=6.0V, Outputs open)	Max. 10µA (fc=0Hz, VCC=6.0V, Outputs open)	
TA (Operating ambient temperature)	-40°C to +85°C	-40°C to +85°C	-30°C to +70°C (Preliminary)	

* Without prescaler.

INPUT/OUTPUT CIRCUITS

All input-only pins are internally pulled up, and all output-only and input/output pins except O-, P-, and R-Ports have push-pull output buffer (standard pull-up). O-, P-, and R-Ports can have push-pull (standard pull-up) or open-drain (standard) buffer using mask option.

Table 3: INPUT/OUTPUT CIRCUITS

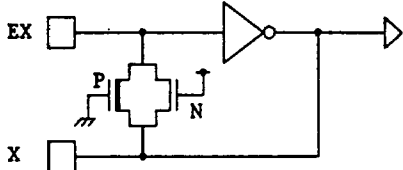
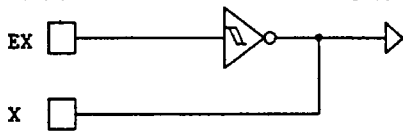
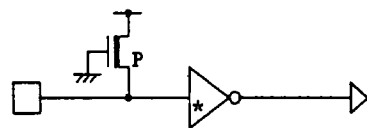
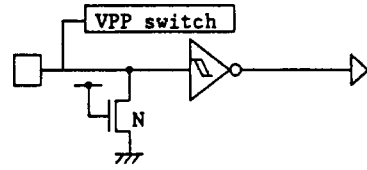
Pin	Circuit	Note
EX, X	<ul style="list-style-type: none"> Crystal/Ceramic OSC or external clock* (-101, -102) 	<ul style="list-style-type: none"> Non-hysteresis inverter Feedback resistor: Approx. 2 MΩ typ. (at $V_{CC}=5V$) * When only external clock drive is used, we recommend RC-network OSC.
	<ul style="list-style-type: none"> RC-Network OSC or external clock* 	<ul style="list-style-type: none"> Hysteresis inverter Without feedback resistor * When only external clock drive is used, we recommend RC-network OSC.
\overline{IRQ} , \overline{TC} , SI, K-Port	<ul style="list-style-type: none"> Input only pin 	<ul style="list-style-type: none"> Input pull-up resistor (P-ch. Tr.): Approx. 300kΩ typ. (at $V_{CC}=5V$) * Hysteresis inverter for \overline{IRQ}, \overline{TC}
START/VPP		<ul style="list-style-type: none"> Input pull-down resistor (N-ch. Tr.): Approx. 300kΩ typ. at ($V_{CC}=5V$)

Table 3: INPUT/OUTPUT CIRCUITS (Continued)

Pin	Circuit	Note
$\overline{\text{RESET}}$,* $\overline{\text{SC/T0}}$,* R0-R3 ,** R6-R14 **	<p>• Input/Output Pin</p>	<p>• Output pull-up resistor (P-ch. Tr.): $\overline{\text{RESET}}$: Approx. 300kΩ typ. $\overline{\text{SC/T0}}$: Approx. 10kΩ typ. (at $V_{CC}=5V$)</p> <p>* Hysteresis inverter for $\overline{\text{RESET}}$, $\overline{\text{SC/T0}}$</p> <p>• Output port options for O-, P-, and R-Port: 1: Standard pull-up(-101): Pull-up resistor (P-ch. Tr.): Approx. 10kΩ typ. (at $V_{CC}=5V$)</p>
S0 , P-Port,** O-Port **	<p>• Output-Only Pin</p>	<p>**2: Standard open-drain(102): Without P-ch. pull-up resistor</p>
R4/WCLK , R5/PROG		<p>• Output pull-up resistor (P-ch. Tr.): 10kΩ typ. (at $V_{CC}=5V$)</p>

USER MASK OPTIONS

The MB88P505H-5XX which user requested option version has the following mask options. (Standard version is refer Table 5 STANDARD VERSION MASK OPTIONS.)

Table 4: MB88P505H-5XX CUSTOMIZED USER MASK OPTIONS

Optional Feature	Symbol	Option	Option No.	Note
Clock Prescaler	CLK	No	0	$f_C=0.5$ MHz to 4 MHz
		Yes	1	$f_C=1$ MHz to 8 MHz
Oscillator Type	OSC	Crystal/ceramic OSC or external clock*	0	
		RC-network OSC or external clock*	1	
Output Port Type	PORT	Standard open-drain	0/L	Output port circuit option selected must be the same for all O-, P-, and R-Ports.
		Standard pull-up	1/L	
Standby Function	STBY	No	0	
		Yes (Software initiation)	1	
Output Port State During Standby	STATE	Hold	0	Output port state option selected must be the same for all O-, P-, and R-Ports.
		High-Z	1	
Standby Off Reset Function	SOR	No	0	
		Yes	1	
Watch-dog Timer Function	WDR	No	0	
		Yes	1	
Output Port (P-Port) Level During Reset	RST	High	0	
		Low	1	O-, and R-Port are fixed at high level

Fujitsu prepared two standard option (Suffix -101 or -102) for MB88P505H and they have the following mask options. For unselected options, Fujitsu can supply for suffix -5XX (Refer to Table 4)

Table 5: MB88P505H-101 AND -102 STANDARD VERSION MASK OPTIONS

Optional Feature	Symbol	MB88P505H-101	MB88P505H-102	Note
Clock Prescaler	CLK	Yes	Yes	fc=1MHz to 8MHz
Oscillator Type	OSC	Crystal/ceramic OSC or external clock*	Crystal/ceramic OSC or external clock*	
Output Port Type	PORT	Standard pull-up	Standard open-drain	
Standby Function	STBY	Yes(Software initiation)	Yes(Software initiation)	
Output Port State During Standby	STATE	High-Z	Hold	
Standby Off Reset Function	SOR	No	No	
Watch-dog Timer Function	WDR	No	No	
Output Port (P-Port) Level During Reset	RST	High	High	

NOTES ON OPERATION

- Prevention Latch-up

Latch-up may occur in CMOS devices when a voltage higher than V_{CC} or lower than V_{SS} is applied to any input or output pin, or when a voltage exceeding the absolute maximum ratings is applied between V_{CC} and V_{SS} pins. If latch-up occurs, the supply current increases greatly, and the device may be thermally destroyed. Therefore, applied voltages should not exceed the maximum ratings.

- Treatment of Unused Pins

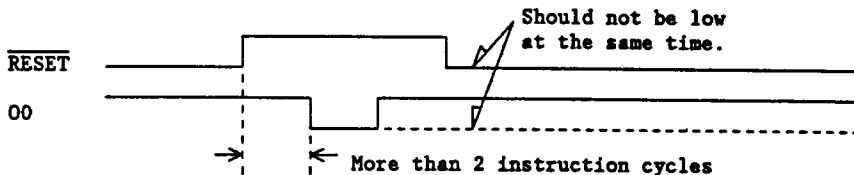
Unused input pins should be pulled up or down with external resistors or they may cause some malfunction. (However, the X pin should be open when an external clock oscillator is used.)

- Special Function of 00 Pin

The 00 pin has another function as a test terminal, in addition to its normal function 0-Port. If the 00 pin is forced low (less than $0.8V_{CC}$) while the RESET pin is low, the MCU is placed in the test mode. Therefore, the 00 pin should not be forced low while the RESET pin is low (when all output ports are initialized).

Especially when the open-drain is selected for the output port option, the 00 pin should be externally pulled up because such open-drain outputs are subject to noise disturbance if left floating.

At least 2 instruction cycles are required to change 00 pin from high to low after releasing reset (RESET: Low \rightarrow High)



- External Capacitors for Crystal Oscillation

Fig. 7 gives an aim of an area where the on-chip oscillator has stable oscillator characteristics and short oscillation stabilization time when an average crystal resonator is used.

The external capacitor should be adjusted to individual crystal resonators when precise oscillation frequency is required. It is recommended to use crystal with a frequency higher than required oscillation frequency, together with the on-chip divided-by-two prescaler, because crystal resonators with lower oscillation frequency generally tends to have longer stabilization time and wider characteristics variation.

NOTES ON OPERATION**• Supply Voltage**

Malfunction may occur even within the recommended operating supply voltage if the supply voltage changes rapidly. Therefore, the supply voltage should be regulated as well as possible. The following conditions are recommended for the power supply:

- (1) V_{CC} ripple (peak-to-peak value) at commercial frequency (50Hz to 60Hz):
Less than 10% of typical V_{CC} value.
 - (2) V_{CC} transient change rate (such as at switching of power supply): Less than 0.1V/ms.
- These devices is different from production version, So, note that Table 2 differences between MB88505/H and MB88P505H.

INSTRUCTION SET DESCRIPTION

The MB88P505H instruction set includes 76 instructions, 86% of which are single-byte and single-cycle, 13% two-byte two-cycle, and 1% two byte three-cycle. The MB88P505H instruction set is exactly the same as the MB88505 and MB88505H instruction set, and is divided into ten functional groups:

- Register-to-register transfer
- Register-to-memory transfer
- Constant transfer
- Arithmetic and logical operations
- Bit manipulation
- Control
- Input/Output
- Branch
- Flag manipulation
- Other

Tables 6 and 7 summarize the MB88P505H instruction set.

Table 6: INSTRUCTION SET SUMMARY

	Mnemonic +operand	Code (Hex.)	Flag/Status			Byte/ Cycle	Operation
			ZF	CF	ST		
Register- to- Register Transfer	TATH	05	.	.	.	1/1	TH←(AC)
	TATL	06	.	.	.	1/1	TL←(AC)
	TAS	07	.	.	.	1/1	SB←(AC)
	TAY	04	.	.	.	1/1	Y←(AC)
	TSA	17	‡	.	.	1/1	4-bit mode: AC←(SB _L), 8-bit mode: AC←(SB _L), X←(SB _H)
	TTHA	15	‡	.	.	1/1	AC←(TH)
	TTLA	16	‡	.	.	1/1	AC←(TL)
	TYA	14	‡	.	.	1/1	AC←(Y)
	XX	1B	‡*1	.	.	1/1	(AC)←(X)
Register- to- Memory Transfer	L	0D	‡	.	.	1/1	AC←{M(X,Y)}
	LS	2B	‡	.	.	1/1	SB←{M(X,Y)}
	ST	1D	.	.	.	1/1	M(X,Y)←(AC)
	STDC	1A	.	.	‡C	1/1	M(X,Y)←(AC), Y←(Y)-1
	STIC	0A	.	.	‡C	1/1	M(X,Y)←(AC), Y←(Y)+1
	STS	2A	‡	.	.	1/1	M(X,Y)←(SB)
	X	0B	‡*1	.	.	1/1	(AC)←{M(X,Y)}
XD D	50-53*	‡*1	.	.	1/1	(AC)←{M(O,D)}; D=0 to 3 (X=0, Y=D)	
XYD D	54-57*	‡*2	.	.	1/1	(Y)←{M(O,D)}; D=4 to 7 (X=0, Y=D)	
Constant Transfer	CLA	90	‡	.	.	1/1	AC←0 (Included in LI instruction)
	LI imm	90-9F*	‡	.	.	1/1	AC←imm; imm=0 to 15
	LXI imm	58-5F*	‡	.	.	1/1	X3←0, X2 to X0←imm; imm=0 to 7
	LXID	3D90- 3D9F*	‡	.	.	2/2	X←imm; imm=0 to 15
	LRXA imm	3D20- 3D3F*	.	.	.	2/3	X←{ROM(imm X Y)}d, d=7-4 AC←{ROM(imm X Y)}d, d=3-0 imm=0 to 31
	LYI imm	80-8F*	‡	.	.	1/1	Y←imm; imm=0 to 15
Arithmetic & Logical Operations	ADC	0E	‡	‡	‡C	1/1	AC←(AC)+{M(X,Y)}+(CF)
	AI imm	3D80- 3D8F	‡	‡	‡C	1/1	AC←(AC)+imm; imm=0 to 15
	AND	0F	‡	.	‡Z	1/1	AC←(AC)∩{M(X,Y)}
	C	2E	‡	‡	‡Z	1/1	{M(X,Y)}-(AC)
	CI imm	B0-BF*	‡	‡	‡Z	1/1	imm-(AC); imm=0 to 15
	CYI imm	A0-AF*	.	.	‡Z	1/1	imm-(Y); imm=0 to 15

Table 6: INSTRUCTION SET SUMMARY (Continued)

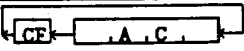
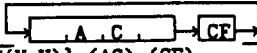
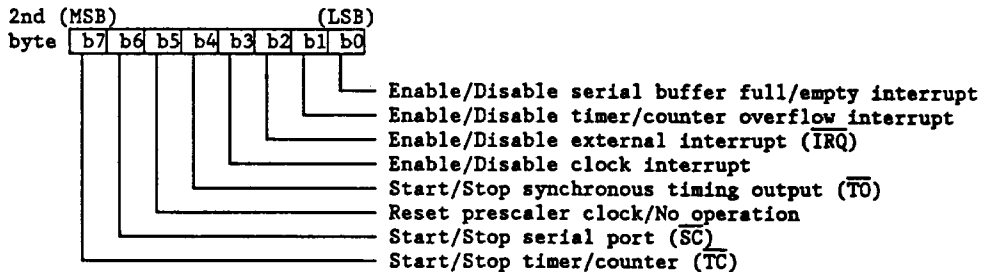
	Mnemonic +Operand	Code (Hex.)	Flag/Status			Byte/ Cycle	Operation
			ZF	CF	ST		
Arithmetic & Logical Operation	DAA	10	.	‡	‡C	1/1	AC+(AC)+6 if (AC)>9 or (CF)=1
	DAS	11	.	‡	‡C	1/1	AC+(AC)+10 if (AC)>9 or (CF)=1
	DCA	3D8F	‡	‡	‡C	1/1	AC+(AC)+15 (Included in AI instruc-
	DCM	19	‡	.	‡C	1/1	M(X,Y)+{M(X,Y)}-1 tion)
	DCY	18	.	.	‡C	1/1	Y+(Y)-1
	EOR	2F	‡	.	‡Z	1/1	AC+{M(X,Y)}⊕(AC)
	ICA	3D81	‡	‡	‡C	1/1	AC+(AC)+1 (Included in AI instruc-
	ICM	09	‡	.	‡C	1/1	M(X,Y)+{M(X,Y)}+1 tion)
	ICX	3DAC	.	.	‡C	2/2	X+(X)+1
	ICY	08	‡	.	‡C	1/1	Y+(Y)+1
	NEG	2D	.	.	‡Z	1/1	AC+(AC)+1
	OR	1F	‡	.	‡Z	1/1	AC+{M(X,Y)}∪(AC)
	ROL	0C	‡	‡	‡C	1/1	
ROR	1C	‡	‡	‡C	1/1		
SBC	1E	‡	‡	‡C	1/1	AC+{M(X,Y)}-(AC)-(CF)	
Bit Manipulation	RBIT bp	34-37*	.	.	.	1/1	{M(X,Y)}bp+0; bp=0 to 3
	SBIT bp	30-33*	.	.	.	1/1	{M(X,Y)}bp+1; bp=0 to 3
	RBA bp	3DA4	.	.	.	2/2	(AC)bp+0 ; bp=0 to 3
	SBA bp	3DA7 *	.	.	.	2/2	(AC)bp+1 ; bp=0 to 3
		3DA0	.	.	.		
TBA bp	4C-4F*	.	.	‡Z	1/1	(AC)bp-1 ; bp=0 to 3	
TBIT bp	38-3B*	.	.	‡Z	1/1	{M(X,Y)}bp-1; bp=0 to 3	
Control	EN imm	3E00- 3EFF*	.	.	.	2/2	Enable the internal resources by the operand byte (2nd byte); *3
	DIS imm	3F00- 3FFF*	.	.	.	2/2	Disable the internal resources by the operand byte (2nd byte); *3
Input/ Output	RST	3DAD	.	.	.	2/2	System initialization
	IN	13	‡	.	.	1/1	AC+(R)Y ; Y=0 to 3 (Port #)
	INK	12	‡	.	.	1/1	AC+(REG)Y; Y=9 to 15
	OUT	03	.	.	.	1/1	AC+(K)
	OUTO	01	.	.	.	1/1	(R)Y+(AC); Y=0 to 3 (Port #)
							(REG)Y+(R); Y=9 to 15
	OUTP	02	.	.	.	1/1	If CF=0 03-00+(AC)
							If CF=1 07-04+(AC)
RSTD d	44-47*	.	.	.	1/1	P+(AC)	
RSTR	22	.	.	.	1/1	(R)d+0; d=0 to 3 (Bit # of Port #0)	
SETD d	40-43*	.	.	.	1/1	(R)Y+0; Y=0 to 15 (Bit #)	
SETR	20	.	.	.	1/1	(R)d+1; d=0 to 3 (Bit # of Port #0)	
TSTD d	48-4B*	.	.	‡Z	1/1	(R)Y+1; Y=0 to 15 (Bit #)	
TSTR	24	.	.	‡Z	1/1	(R)d-1; d=8 to 11 (Bit #)	
Branch	CALL addr	6000-	.	.	.	2/2	If ST=1, Subroutine Call for addr; addr=0 to 4095. ST=0, Not Subroutine Call.
		6FFF*	.	.	.		

Table 6: INSTRUCTION SET SUMMARY (Continued)

	Mnemonic +Operand	Code (Hex.)	Flag/Status			Byte/ Cycle	Operation
			ZF	CF	ST		
Branch	JMP addr	C0-FF*	.	.	.	1/1	If ST=1, Branch to addr; addr=0 to 63 ST=0, No Branch.
	JPKY addr	3D00- 3D1F*	.	.	.	2/2	Branch always to addr on page #n;
	JPL addr	7000- 7FFF*	.	.	.	2/2	If ST=1, Branch to addr; addr=0 to 4095. ST=0, No Branch.
	RTI	3C	.	.	.	1/1	Return From Interrupt Routine
	RTS	2C	.	.	.	1/1	Return From Subroutine
Flag Manipulation	RSTC	23	.	↓	.	1/1	CF+0
	SETC	21	.	↑	.	1/1	CF+1
	TSTC	28	.	.	↓CF	1/1	(CF)-1
	TSTI	25	.	.	↓IF	1/1	(IF)-1, (If $\overline{IRQ}=L$, IF=1)
	TSTS	27	.	.	↓SF	1/1	(SF)-1, SF+0
	TSTV	26	.	.	↓VF	1/1	(VF)-1, VF+0
	TSTZ	29	.	.	↓ZF	1/1	(ZF)-1
Other	NOP	00	.	.	.	1/1	No Operation

Notes:

- *1: ZF is set or reset depending on contents of AC after instruction execution.
 *2: ZF is set or reset depending on contents of Y after instruction execution.
 *3: Each bit of the operand (the second byte) functions as follows:



Symbols and Abbreviations

<u>Symbols</u>	<u>Meaning</u>
←	Is transferred to
*	Is exchanged with
+	Arithmetic plus
-	Arithmetic minus
⊕	Logical exclusive or
∩	Logical OR
∪	Logical AND
<u> </u>	Negation
()	Contents of parenthesis
↑	Set to "1" always
↓	Set to "0" always
‡	Affected (set or reset) by operation results
↓C	Set to "0" due to carry (not carry flag)
↓CF	Set to "0" due to carry flag
↓IF	Set to "0" due to interrupt flag
↓SF	Set to "0" due to serial buffer full/empty flag
↓VF	Set to "0" due to timer/counter overflow flag
↓Z	Set to "0" due to zero (not zero flag)
↓ZF	Set to "0" due to zero flag
.	Not affected

<u>Abbreviation</u>	<u>Meaning</u>
AC	Accumulator
addr	Jump address
bp	Bit pointer (that is part of the instruction code)
C	Carry
CF	Carry flag
d	Direct line number (that is part of the instruction code)
IF	Interrupt flag
<u>imm</u>	Immediate data
IRQ	Interrupt request
K	K-Port (K3 to K0)
LSB	Least significant bit
M(X,Y)	Data memory (RAM) location indirectly addressed by data pointer (X- and Y-registers)
M(0,D)	Data memory (RAM) location directly addressed by "D" bits in the instruction code, in page #0 (X=0)
MSB	Most significant bit
O	O-Port (O7-O0)
R	R-Port (#0: R3-R0, #1: R7-R4, #2: R11-R8, #3: R14-R12)
(R)Y; Y=n	① R-Port #n specified by Y-register (Y=0 to 3)
	② R-Port bit n specified by Y-register (Y=0 to 14)
(R)d; d=n	R-Port bit n specified by "d" bits in the instruction code
SB	Serial buffer register
SF	Serial buffer full/empty flag
ST	Status flag
TH	Timer/counter high byte
TL	Timer/counter low byte
VF	Timer/counter overflow flag
X	X-register (that indicates page # in data memory RAM)
Xn	The n-th bit X-register
Y	Y-register
Z	Zero
ZF	Zero flag

Table 7: INSTRUCTION CODES SUMMARY

L H	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	NOP	OUTC	OUTP	OUT	TAY	TATH	TATL	TAS	ICY	ICM	STIC	X	ROL	L	ADC	AND
1	DAA	DAS	INK	IN	TYA	TTHA	TTLA	TSA	DCY	DCM	STDC	XX	ROR	ST	SBC	OR
2	SETR	SETC	RSTR	RSTC	TSTR	TSTI	TSTV	TSTS	TSTC	TSTZ	STS	LS	RTS	NEG	C	EOR
3	SBIT bp				RBIT bp				TBIT bp				RTI	* EXT	EN imm	DIS imm
4	SETD d				RSTD d				TSTD d				TBA bp			
5	XD D				XYD D				LXI imm							
6	CALL addr															
7	JPL addr															
8	LYI imm															
9	(CLA)	LI imm														
A	CYI imm															
B	CI imm															
C	JMP addr															
D																
E																
F																

3

Note: : 1-byte/1-cycle instruction

: 2-bytes/2-cycles instruction

* See the next page



Table 7: INSTRUCTION CODES SUMMARY (Continued)
 Extended instruction

3DL 3DR	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	JPXY addr															
1																
2	LRXA imm															
3																
4	NOT USED															
5																
6	NOT USED															
7																
8	(ICA)	AI imm														(DCA)
9	LXID imm															
A	SBA bp				RBA bp				NOT USED				ICX	RST	NOT USED	
B	NOT USED															
C	NOT USED															
D																
E	NOT USED															
F																

PRODUCT LINE-UP AND DEVELOPMENT TOOLS

The MB88P505H consists of the standard version (MB88P505H-101-P and MB88P505H-102-P) and customized devices (MB88P505H-5XX).

Table 8: MB88P505H PRODUCT LINE-UP & DEVELOPMENT TOOLS

	MB88P505H-101-P	MB88P505H-102-P	MB88P505H-5XX-P
ROM Size	4K x 8 bits (On-chip One Time Programmable ROM)		
RAM Size (Directly addressed locations)	256 x 4 bits (0-7)		
I/O Port:	Total 36 lines		
-Input only port	4		
-Output only port	12		
-I/O port	15		
-Control port	5 (Including serial I/O)		
Output Port Type	Standard pull-up	Standard open-drain	Standard pull-up Standard open-drain
Stack Depth (Nesting level)	8 levels		
Timer/Counter:	Yes		
-Buffer size	8 bits		
-Clock source	Internal/External		
Serial I/O:	Yes		
-Buffer size	4/8 bits		
-Clock source	Internal/External		
-Output latch	Yes		
Clock Generator:	Yes		Yes
-Oscillator type	Crystal/External (Fixed)		Crystal/External RC-Network/External (Option)
-Clock Frequency (With prescaler)	-		0.5 MHz - 4 MHz
	(1 MHz-8 MHz)		(1 MHz - 8 MHz)
Clock Prescaler (Divid-by-two)	Yes (Fixed)		Yes/No (Option)
Interrupt Function	Yes		
-Nesting level	Single level		
-Interrupt sources	4 sources		
Standby Function:	<ul style="list-style-type: none"> • Yes (Fixed) • Software • Idle/Stop (Software selectable) • High-Z • No (Fixed) 		<ul style="list-style-type: none"> • Yes/No (Option) • Software • Idle/Stop (Software selectable) • Hold/High-Z (Option) • Yes/No (Option)
-Initiation method			
-Oscillator state during standby			
-Output state during standby			
-Standby off reset function			
Output Port(P-Port) Level During Reset	High (Fixed)		High/Low (Option)
Watch Dog Timer Function	No (Fixed)		Yes/No (Option)

Table 8: MB88500H SERIES PRODUCT LINE-UP & DEVELOPMENT TOOLS

	MB88P505H-101-P	MB88P505H-102-P	MB88P505H-XXX-P
Number of Instructions	76		
Instruction Length/Cycle	1/1, 2/2, or 2/3		
Min. Instruction Execution Time	1.5 μ s at 8 MHz (With prescaler)		
Power Supply:	Single +5V		
-Active	· 4.5V to 5.5V		
-Standby	· 3.5V to 6.0V		
Operating Temp. Range:	-30°C to +70°C		
Process	CMOS		
Package	DIP-42P		DIP-42P SH-DIP-42P FPT-48P
Development Tools:			
-Hardware	MB2115-01 : CRT unit (Common) MB2115-02 : Monitor board with keyboard (Common) MB2115-31A : DUE board MB2115-100 : OTPROM writer MB2115-102 : Socket adapter for MB88P505H		
-Software	SM05215-A010: Intellec series III MDS cross-assembler SM07415-A012: CP/M-86 cross-assembler SMXXXXX-XXXX: PC-DOS cross-assembler SM07415-G022: CP/M-86 host emulator SMXXXXX-XXXX: PC-DOS host emulator		

ELECTRICAL CHARACTERISTICS

• ABSOLUTE MAXIMUM RATINGS †

Parameter	Symbol	Rating			Unit	Remarks
		Min.	Typ.	Max.		
Supply Voltage	V _{CC}	V _{SS} -0.3		V _{SS} +7.0	V	
	V _{SS}		0		V	
Input Voltage	V _{IN}	V _{SS} -0.3		V _{SS} +7.0	V	Should not exceed V _{CC} +0.3V.
Output Voltage	V _{OUT}	V _{SS} -0.3		V _{SS} +7.0	V	Should not exceed V _{CC} +0.3V.
Power Dissipation	P _D			600	mW	
Operating Ambient Temperature	T _A	-30		+70	°C	
Storage Temperature	T _{STG}	-55		+150	°C	Differed from produced device.

† Permanent device damage may occur if the above ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

• RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value			Unit	Remarks
		Min.	Typ.	Max.		
Supply Voltage	V _{CC}	4.5	5.0	5.5	V	Active operation range
		3.5		6.0	V	Standby operation range
	V _{SS}		0		V	
Input High Voltage	V _{IH}	0.75·V _{CC}		V _{CC} +0.3	V	K-Port, SI
	V _{IHS}	0.8·V _{CC}		V _{CC} +0.3	V	EX, START, SC/TO, IRQ, TC, RESET
Input Low Voltage	V _{IL}	V _{SS} -0.3		0.25·V _{CC}	V	K-Port, SI
	V _{ILS}	V _{SS} -0.3		0.2·V _{CC}	V	EX, START, SC/TO, IRQ, TC, RESET
Operating Ambient Temperature	T _A	-30		+70	°C	Differed from produced devices.

• DC CHARACTERISTICS

(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Pin/Port	Condition	Value			Unit
				Min.	Typ.	Max.	
Output High Voltage	VOH	O-, P-, R-Ports (Standard pull-up), SC/TO, SO	VCC=4.5V IOH=-200µA	2.4			V
			VCC=4.5V IOH=-10µA	4.0			V
Output Low Voltage	VOL	O-, P-, R-Ports (All output options), SC/TO, SO, RESET	VCC=4.5V IOL=1.8mA			0.4	V
			VCC=4.5V IOL=3.6mA			0.6	V
Input Leakage Current	IIH	START, EX	VCC=5.5V VIH=5.5V			60	mA
	IIL	R-Port(Standard pull-up), SC/TO	VCC=5.5V VIL=0.4V			-1.8	mA
		EX, K-Port, SI, RESET, IRQ, TC	VCC=5.5V VIL=0.4V			-60	µA
Open-Drain Output Leakage Current	I _{LEAK}	O-, P-, R-Ports (Standard open-drain)	VCC=5.5V VOH=5.5V Output in high-Z		0.1	10	µA
Total I/O Leakage Current (High-Z)	ΣI _{IZ}	All pins except VCC, VSS, EX and RESET	VCC=5.5V(Standby), VIN=0V to 6.0V, High-Z state			±10	µA
Supply Current	ICC	VCC	VCC=5.0V(Typ.), 5.5V(Max.) fc=1MHz(Active), All outputs open		2	6	mA
	ICCH	VCC (With standby function)	VCC=6.0V fc=0(Standby), All outputs open			10	µA
Input Capacitance	CIN	All pins except VCC and VSS	fc=1MHz		10	20	pF

• AC CHARACTERISTICS

CLOCK TIMING

(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min.	Max.		
Clock Frequency	f_c	EX, X	Crystal/ceramic or RC-network OSC or external clock drive: Figs. 4 and 5	0.5	4	MHz	Without prescaler
				1	8		With prescaler
Clock Cycle Time	t_{cyc}	EX, X	Figs. 4 and 5	0.25	2	μs	
Input Clock Pulse Width	PWCH, PWCL	EX	External clock drive (with X open): Figs. 4 and 5	100		ns	Without prescaler
				50			With prescaler
Input Clock Rise/Fall Time	t_{cr} , t_{cf}	EX	External clock drive (with X open): Figs. 4 and 5	5	200	ns	

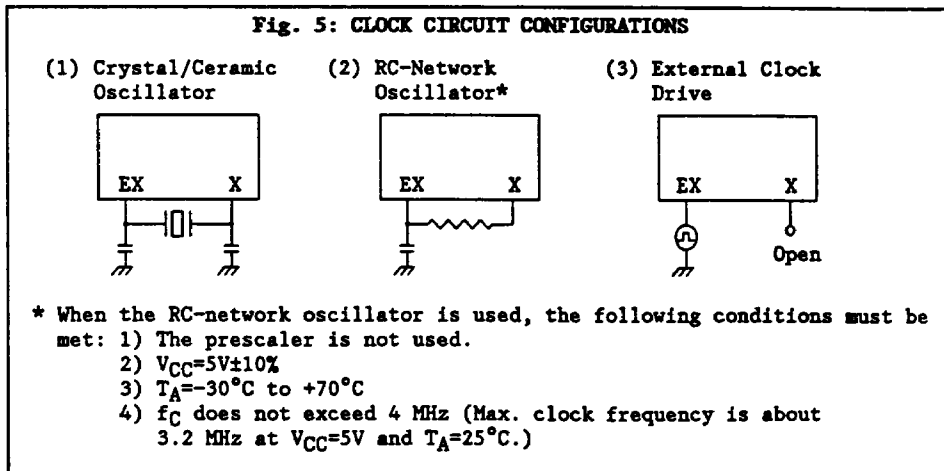
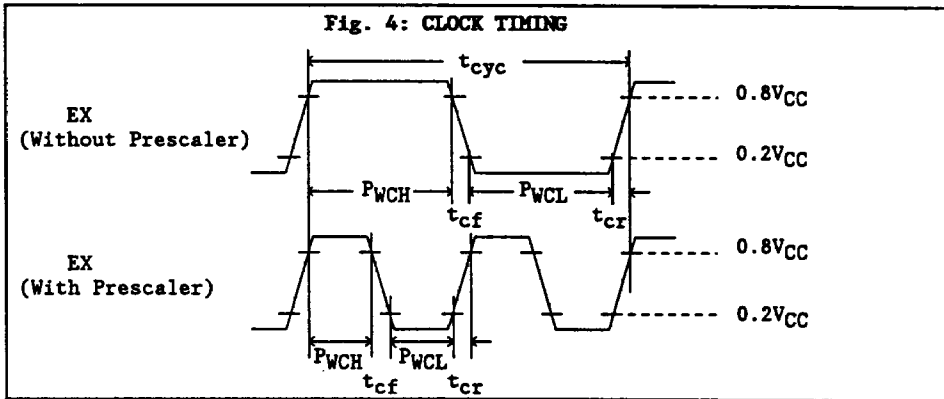
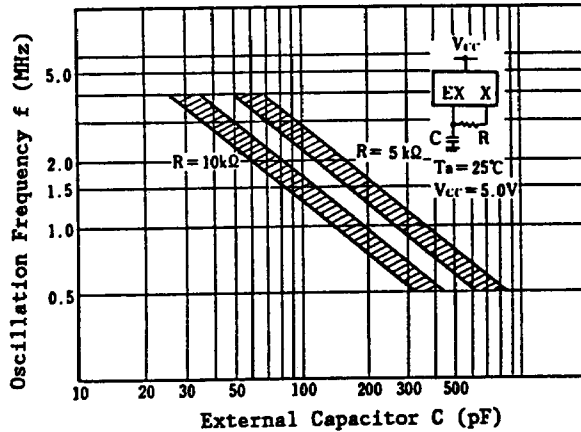


Fig. 6: RC-NETWORK OSCILLATOR CHARACTERISTICS (EXAMPLE)

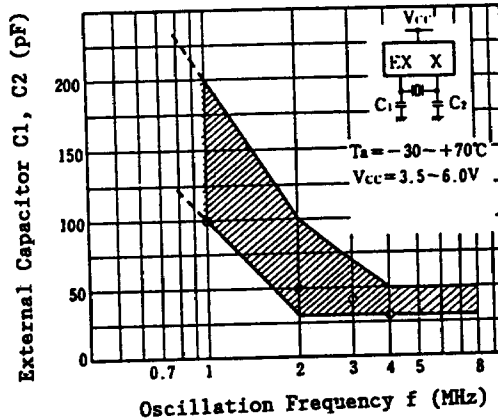


Note:

When the RC-network oscillator is used, the following conditions must be met:

- 1) The prescaler is not used. 2) $V_{CC} = 5V \pm 10\%$
- 3) $T_A = -30^\circ C$ to $+70^\circ C$
- 4) f_c does not exceed 3.2 MHz.

Fig. 7: CRYSTAL OSCILLATOR CHARACTERISTICS (EXAMPLE)



Notes:

- 1) The cross-hatched portion is an area where the on-chip oscillator has stable characteristics and short stabilization time when a typical crystal resonator is used. This chart gives an target value of the external capacitor to realize the desired frequency. When an exact frequency is needed, capacitor value should be determined, adjusted to individual crystal resonator characteristics.
- 2) Generally speaking, crystal resonators with lower oscillation frequency tend to have longer stabilization time and wider characteristic variations which affect on-chip oscillator characteristics. So, we recommend a high-frequency crystal resonator with on-chip 1/2 prescaler.

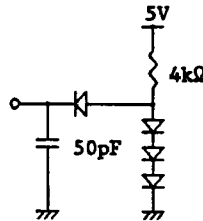
OUTPUT TIMING

(Recommended operating conditions unless otherwise noted.)

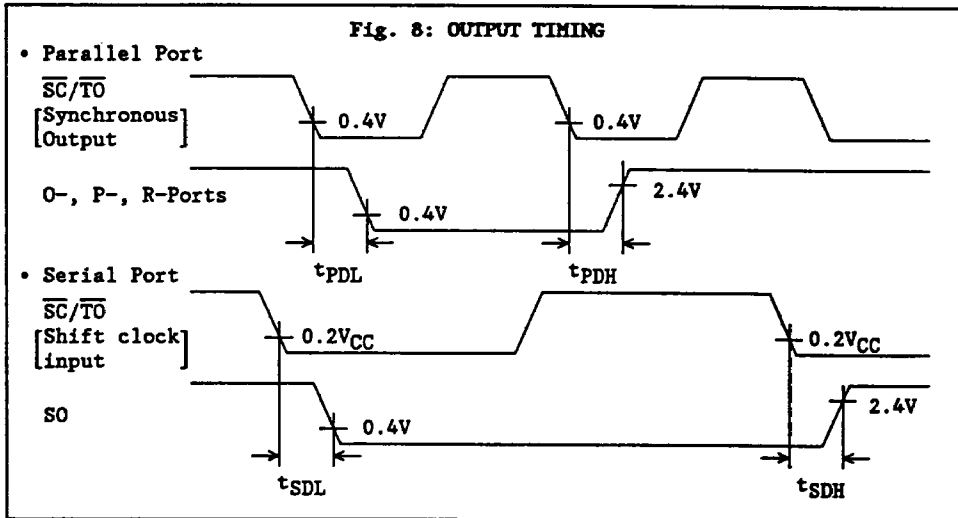
Parameter	Symbol	Pin/Port	Condi- tions	Value		Unit
				Min.	Max.	
O-, P-, R-Ports Delay Time	t _{PDH}	O-Port, P-Port, R-Port	Fig. 8		1000	ns
	t _{PDL}				350	
Serial Port Delay Time	t _{SDH}	SO	Fig. 8		1000	ns
	t _{SDL}				350	

Notes:

1. A 10kΩ pull-up is required when open-drain output is used.
2. All the output loading values are 50pF + 1TTL. See figure below.



3

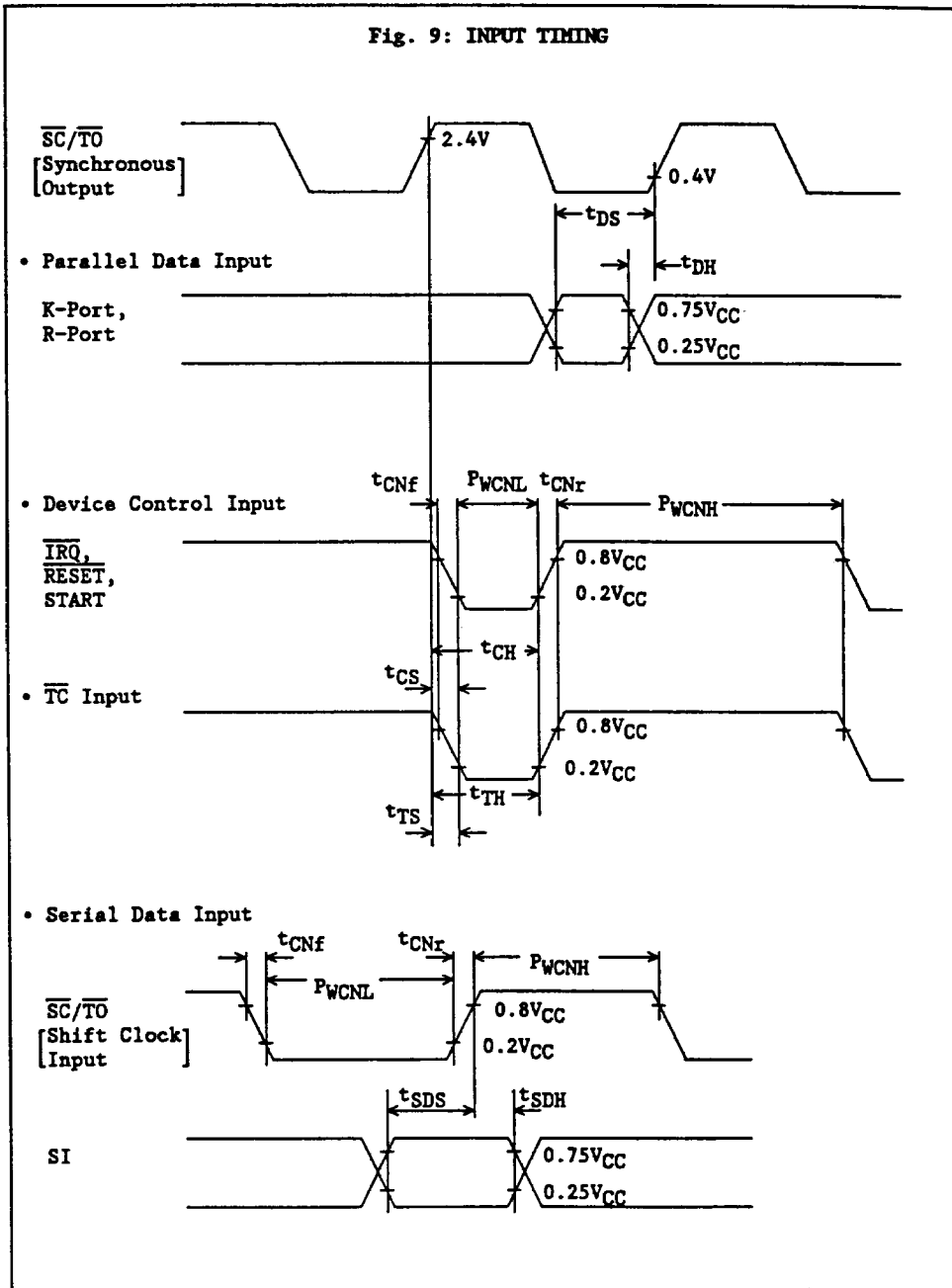


INPUT TIMING

(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Pin/Port	Conditions	Value		Unit
				Min.	Max.	
Input Data Setup Time	t_{DS}	K-Port, R-Port	Fig. 9	$t_{cyc}+1000$		ns
Input Data Hold Time	t_{DH}				$t_{cyc}-50$	
SI Input Setup Time	t_{SDS}	SI	Fig. 9	600		ns
SI Input Hold Time	t_{SDH}			600		
Device Control Setup Time (Synchronous mode)	t_{CS}	\overline{RESET}	Fig. 9		$2t_{cyc}-200$	ns
		\overline{IRQ}			$2t_{cyc}-200$	
Device Control Hold Time (Synchronous mode)	t_{CH}	\overline{RESET}	Fig. 9	$8t_{cyc}+50$		ns
		\overline{IRQ}		$2t_{cyc}+50$		
Timing Input Setup Time (synchronous mode)	t_{TS}	\overline{TC}	Fig. 9		$2t_{cyc}-200$	ns
Timing Input Hold Time (Synchronous mode)	t_{TH}	\overline{TC}	Fig. 9	$2t_{cyc}+50$		ns
Control Signal Low Level Time (Asynchronous mode)	PWCNL	$\overline{SC}/\overline{TO}$	Fig. 9	$6t_{cyc}+250$		ns
		$\overline{IRQ}, \overline{TC}$		$6t_{cyc}+250$		
		\overline{RESET}		$12t_{cyc}+250$		
Control Signal High Level Time (Asynchronous mode)	PWCNH	$\overline{SC}/\overline{TO}$	Fig. 9	$12t_{cyc}+250$		ns
		$\overline{RESET}, \overline{TC}, \overline{IRQ}$		$6t_{cyc}+250$		
		START		500		
Control Signal Rise and Fall Time	t_{CNr}, t_{CNf}	START, $\overline{SC}/\overline{TO}, \overline{IRQ}$ $\overline{RESET}, \overline{TC}$	Fig. 9	Should be less than 200ns		

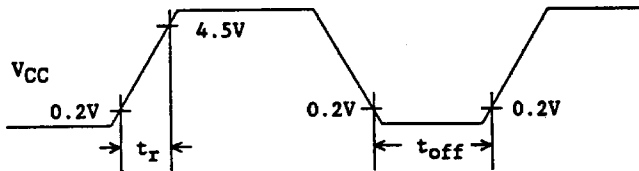
Fig. 9: INPUT TIMING



• POWER-ON RESET

Parameter	Symbol	Condi- tions	Value		Unit	Remarks
			Min.	Max.		
Power Supply Rise Time	t_r	Fig. 10	0.05	50	ms	Required for operation of the power-on reset circuit
Power Supply Shut-off Time	t_{off}	Fig. 10	1		ms	Required for accurate circuit operation repeatability

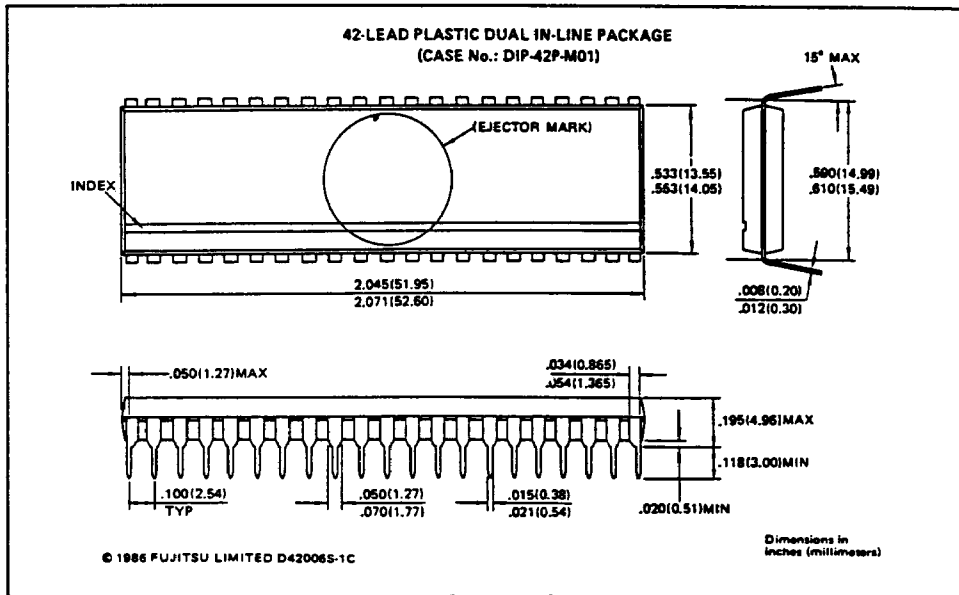
Fig. 10: POWER-ON RESET TIMING



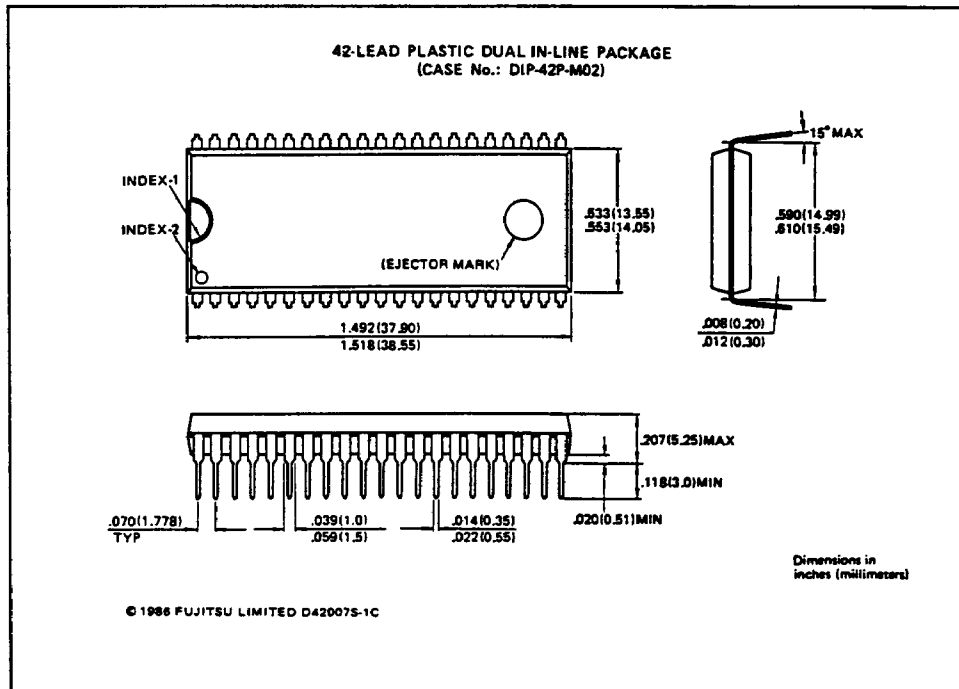
Note:
Power supply should be raised smoothly.

PACKAGE DIMENSIONS

- MB88P505H-P: 42-PIN PLASTIC STANDARD DIP (Standard version)

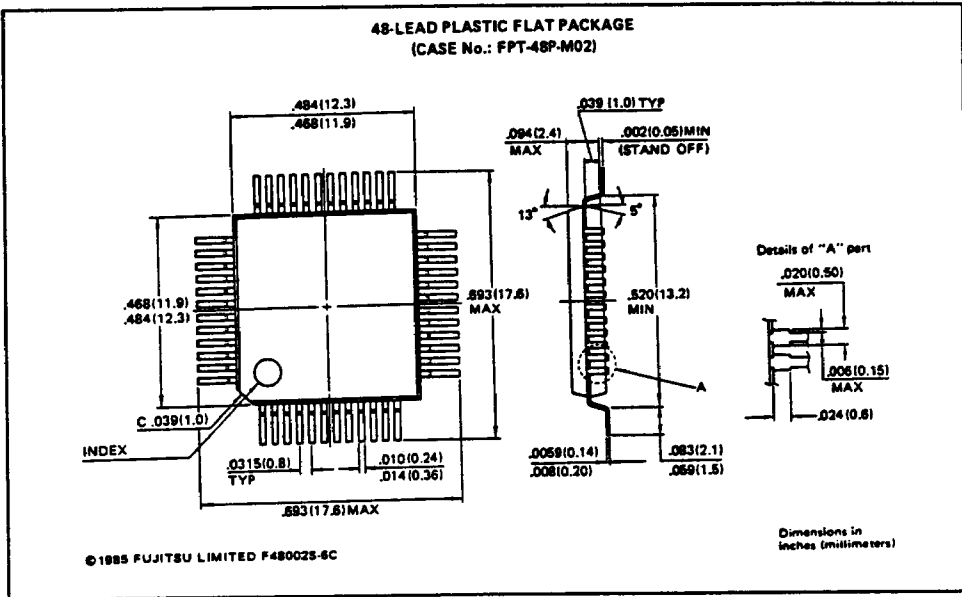


- MB88505H-PSH: 42-PIN PLASTIC SHRINK DIP



PACKAGE DIMENSIONS (Continues)

• MB88P505H-PF: 48-PIN PLASTIC FLAT PACKAGE



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